TOSHIBA Multichip Discrete Device

HN7G07FU

Power Management Switch Applications, Inverter Circuit Applications, Driver Circuit Applications and Interface Circuit Applications

 Combining transistor and BRT reduces the parts count, enabling the design of more compact equipment with a simpler system configuration.

Q1: 2SC5376F equivalent Q2: RN1115F equivalent

Q1 Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Collector-base voltage	V_{CBO}	15	V
Collector-emitter voltage	V _{CEO}	12	V
Emitter-base voltage	V _{EBO}	5	V
Collector current	I _C	500	mA
Base current	Ι _Β	50	mA

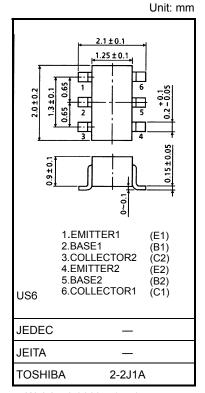
Q2 Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Collector-base voltage	V_{CBO}	50	V
Collector-emitter voltage	V _{CEO}	50	V
Emitter-base voltage	V _{EBO}	10	V
Collector current	Ic	100	mA

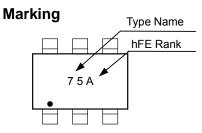
Q1, Q2 Common Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Collector power dissipation	P _C *	200	mW
Junction temperature	Tj	150	°C
Storage temperature range	T _{stg}	-55~150	°C

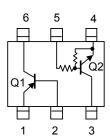
^{*:} Total rating. 130 mW per element should not be exceeded.



Weight: 0.0068 g (typ.)



Equivalent Circuit (top view)



Q1 Electrical Characteristics (Ta = 25°C)

Charac	teristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cutoff curre	nt	I _{CBO}	$V_{CB} = 15 \text{ V}, I_E = 0$	_	_	100	nA
Emitter cutoff current		I _{EBO}	V _{EB} = 5 V, I _C = 0	_	_	100	nA
DC current gain		h _{FE} **	V _{CE} = 2 V, I _C = 10 mA	300	_	1000	
Collector-emitter saturation voltage		V _{CE} (sat) (1)	$I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$	_	15	30	mV
		V _{CE (sat) (2)}	$I_C = 200 \text{ mA}, I_B = 10 \text{ mA}$	_	110	250	
Base-emitter saturati	on voltage	V _{BE (sat)}	$I_C = 200 \text{ mA}, I_B = 10 \text{ mA}$	_	0.87	1.2	V
Transition frequency		f _T	$V_{CE} = 2 \text{ V}, I_{C} = 10 \text{ mA}$	_	130	_	MHz
Collector output capa	citance	C _{ob}	V _{CB} = 10 V, I _E = 0, f = 1 MHz	_	4.2	_	pF
Switching time	Turn-on time	t _{on}	OUTPUT O V INPUT 300 Ω C C C C C C C C C C C C C C C C C C	_	85	_	ns
	Storage time	t _{stg}		_	170	_	ns
	Fall time	t _f	$V_{BB} = 3 \text{ V}$ Duty cycle $\leq 2\%$ $IB1 = IB2 = 5 \text{ mA}$	_	40	_	ns

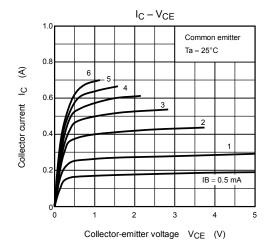
^{**:} h_{FE} Classification

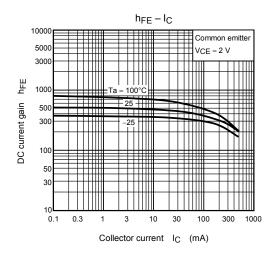
Q2 Electrical Characteristics (Ta = 25°C)

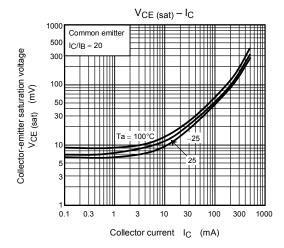
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cutoff current	I _{CBO}	$V_{CB} = 50 \text{ V}, I_E = 0$	_	_	100	nA
	I _{CEO}	$V_{CE} = 50 \text{ V}, I_{E} = 0$			500	nA
Emitter cutoff current	I _{EBO}	$V_{EB} = 6 \text{ V}, I_{C} = 0$	0.37		0.71	mA
DC current gain	h _{FE}	$V_{CE} = 5 \text{ V}, I_{C} = 10 \text{ mA}$	50	_	_	
Collector-emitter saturation voltage	V _{CE (sat)}	$I_C = 5 \text{ mA}, I_B = 0.25 \text{ mA}$	_	0.1	0.3	V
Input voltage (ON)	V _{I(ON)}	$V_{CE} = 0.2 \text{ V}, I_{C} = 5 \text{ mA}$	0.7	_	2.5	V
Input voltage (OFF)	V _{I(OFF)}	V _{CE} = 5 V, I _C = 0.1 mA	0.3	_	1.0	V
Transition frequency	f _T	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}$	_	250	_	MHz
Collector output capacitance	C _{ob}	V _{CB} = 10 V, I _E = 0, f = 1 MHz	_	3	_	pF
Input resistor	R1	_	1.54	2.2	2.86	kΩ
Resistor ratio	R1/R2	_	_	0.22	_	

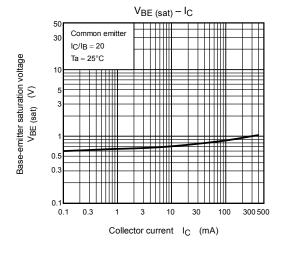
A:300~600, B:500~1000

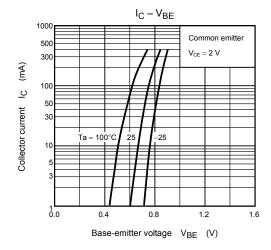
Q1

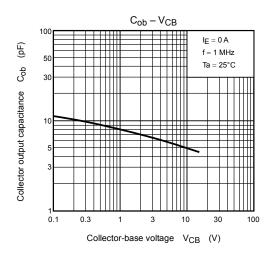




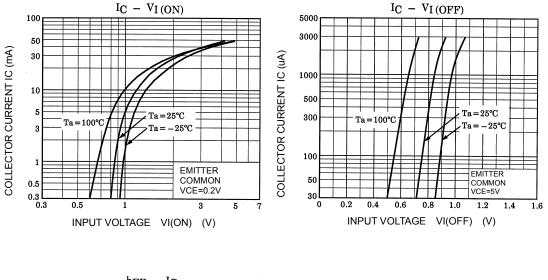


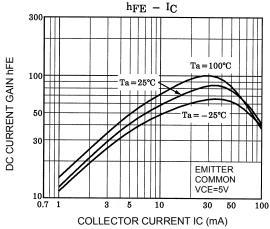


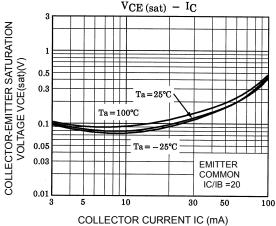




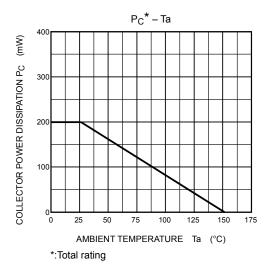
Q2







Q1, Q2 common



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